	1	2	3	4		5	6	7		8	
Ιſ							ł		ł		
	Rolls America Constant Rolls America					Recommended configuration of plated through holes for press-in termination					_
А	HARTING har-bus® HM power female connector RoHS			In addition to the hot-air-level (HAL), other PCB surfaces are getting more		Drilled hole Ø	1,15±0,025 mm				
						important. Due to their different proper	ties - such as mechanical strength and	Tin plated PCB (HAL)	Sn	max. 15 µm	-
		-				<ul> <li>coefficient of friction – we recommend t through holes.</li> </ul>	ne following configuration of PLB	acc. to EN 60352-5	plated hole Ø	0,94 - 1,09 mm	
	General information	:						Chemical tin plated	Drilled hole Ø	1,15±0,025 mm	<u> </u>
						drilled hole $arnothing$	I	PCB	Sn	min. 0,8µm	-
	Design	OBSAI system spec	cification V1.1				Cu min. 25µm		plated hole Ø Drilled hole Ø	1,00 - 1,10 mm 1,15±0,025 mm	
	No. of contacts	up to 4 3,0mm					Ni	3 – 7 µm			
	Contact spacing Test voltage									0,05 - 0,12 µm	
	Contact resistance	max. 1mOhm							plated hole Ø Drilled hole Ø	1,00 - 1,10 mm 1,15±0,025 mm	
в	Insulation resistance	min. 10 <sup>12</sup> 0hm					Silver plated PCB		0,1 - 0,3 μm	−  в	
	Working support	max. 23A at 70°C	(with OBSAI configuation)			finished hole Ø	┝─━┥		plated hole Ø	1,00 - 1,10 mm	
	Working current	max. 20A at 70°C	(fully loaded with power conta	acts)		plating (e.g. Sn)		Copper plated	Drilled hole Ø	1,15±0,025 mm	$\exists \mid  $
	Temperature range	-55°C +125°C		· · · · · · · · · · · · · · · · · · ·				Ρ̈́ĊΒ (OSP)	plated hole Ø	1,00 – 1,10 mm	<b>-</b>
	Termination technology	press-in									
	Clearance & creepage distance	0,6 mm each for fr									_ 🗖
	Insertion and withdrawal force	insertion force per withdrawal force p		max. V min.	Assembly instructions					_	
	Mating cycles	- PL2 acc. to IEC 6		mating cycles	It is highly recommended to use HARTING press-in tools to ensure a reliable press-in process. Please refer to the catalogue for tools, machines and further					r	
	UL file	E102079				information about the press-in process.					
С	RoHS – compliant	Yes									C
	Leadfree	Yes									
	Insulator material	-									
	-Material Colour	RAL 7032 (grey)	cs, glass fiber reinforcement 30%)								
	UL classification										
	Material group acc. to IEC 60664-1	UL 94-V0 IIIa (175 <u>&lt;</u> CTI < 40	00)								
	NFF classification	I3, F4									
D											D
	Contact material										
	Contact material	Copper alloy									
	<u>Plating press-in zone</u> Plating contact zone	Ni Au over Ni									
			· · · · · · · · · · · · · · · · · · ·								
	Derating diagram acc. to IEC 60512-5 (Curren										
	Loaded with four power contacts, each contact can carry up to 50										
	20A @ 70°C / 80% derating.		А —		<u> </u>						
E	With a configuration of two power contacts, (		40		+-1						E
	the current carrying capacity is even up to	UND ANU ENA,	_ }		++						
	23A @ 70°C / 80% derating per contact.		[4] <sub>30</sub>		+						
			L Coa		+-1						
			20		+-1	All Dimensions in mm	Scale Free size tol.		Ref.		
			C Electrical		+-1	Original Size DIN A3	1:1		Sub. DS 17 66 210 01 01 / E	 EC01567 / 22.05.2012	-
			ш 10		+	All rights reserved	Created by Inspected by	Standardisation		State	-
					N		THIELEMANN TADJE	KOHLER	2014-07-10	Final Release	
_					120	Department EC PD - DE	Title har-bus® HM power	famala connector		Doc-Key / ECM-Nr 100580931/UGD/000//	r. /A —
F	°C					HARTING Electronics GmbH				100580931/UGD/000// 500000076072	
	Temperature [°C]				D-32339 Espelkamp Type DS Number 1766210		00101		Rev. A Pac		
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n	·				
		Drilled hole Ø	1,15±0,025 mm	A	
and	Tin plated PCB (HAL)	Sn	max. 15 µm		
		plated hole Ø	0,94 - 1,09 mm		
		Drilled hole Ø	1,15±0,025 mm		
	Chemical tin plated PCB	Sn	min. 0,8µm		
		plated hole Ø	1,00 - 1,10 mm		
		Drilled hole Ø	1,15±0,025 mm		
	Gold /Nickel plated	Ni	3 - 7 µm		
	PCB	Au	0,05 - 0,12 µm		
		plated hole Ø	1,00 - 1,10 mm		
		Drilled hole ${\mathscr B}$	1,15±0,025 mm		
	Silver plated PCB	Ag	0,1 - 0,3 µm	B	
		plated hole Ø	1,00 - 1,10 mm		
	Copper plated	Drilled hole Ø	1,15±0,025 mm		
	PCB (OSP)	plated hole Ø	1,00 - 1,10 mm		
pres	ss-in process. Please ref	er to the catalogue for t	ools, machines and further		
				l c	

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